

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10594206			
<b>Filing Date:</b>				
<b>Title of Invention:</b>	Resin composition, resin-attached metal foil, base material-attached insulating sheet and multiple-layered printed wiring board			
<b>First Named Inventor/Applicant Name:</b>	Masataka Arai			
<b>Filer:</b>	Robert G. Weilacher/Bess Murray			
<b>Attorney Docket Number:</b>	033036.113			
Filed as Large Entity				
<b>U.S. National Stage under 35 USC 371 Filing Fees</b>				
<b>Description</b>	<b>Fee Code</b>	<b>Quantity</b>	<b>Amount</b>	<b>Sub-Total in USD(\$)</b>
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
Eng. Transl. > 30 mo. from priority date	1618	1	130	130
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
Post-Allowance-and-Post-Issuance:				
<b>Extension-of-Time:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				130